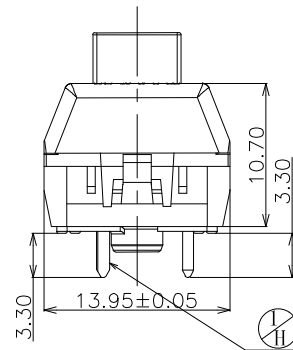
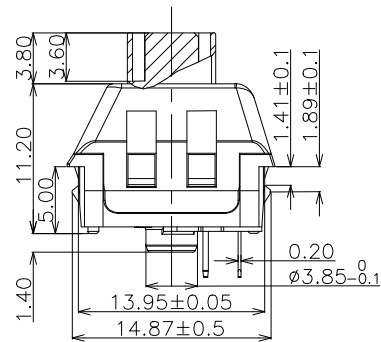
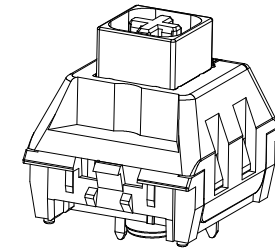
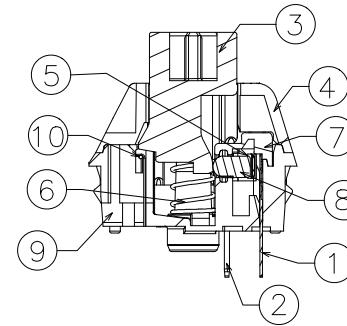
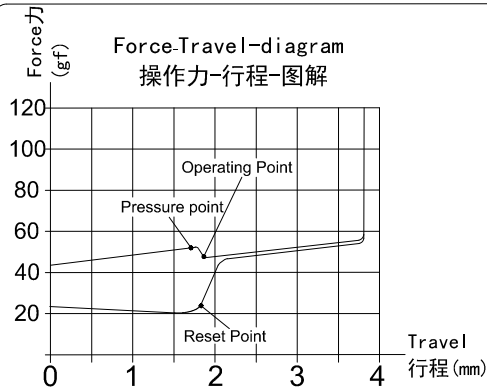
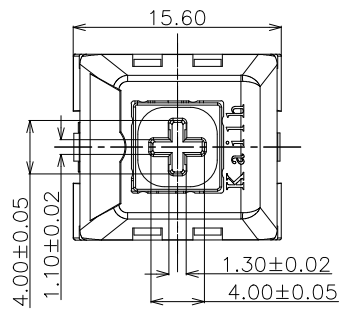
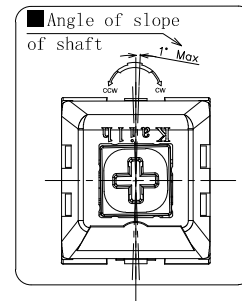
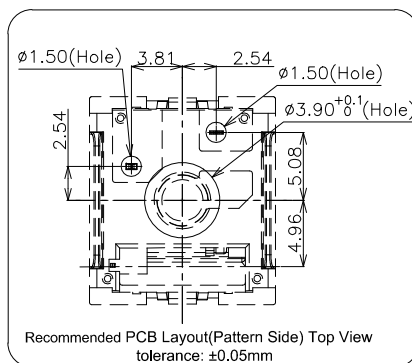
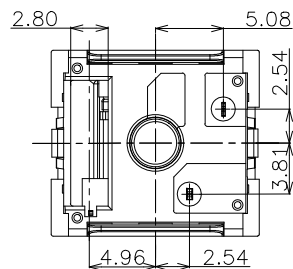
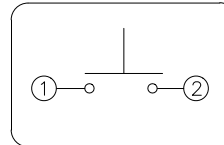


B

White shaft





■ SWITCH FUNCTION



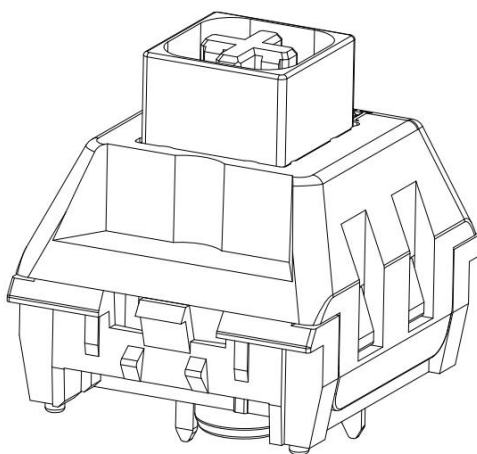
- Specification :
 - 1. Rating: 12 VAC/DC max. 2 VDC min.
10mA AC/DC max. 10 μ A DC min.
 - 2. Contact Resistance: 200m Ω Max
 - 3. Insulation Resistance: 100M Ω Min. (DC100V)
 - 4. Withstand Voltage: AC100V(50~60Hz) for 1 minute
 - 5. Tactile Force: 55 \pm 10gf
 - 6. Operation Force: 45 \pm 15gf
 - 7. Return Force: \geq 15gf
 - 8. Conduction travel: 1.80 \pm 0.3mm
 - 9. Total travel: 3.60 \pm 0.3mm
 - 10. Electrical Life: 80,000,000 Cycles(min).
 - 11. Degree of protection: IP54(excluding the terminals)
- <Feel is allowed to have difference before and after life test>

⑩	Torsional Spring	_____	1	Stainless Steel	Nature	_____
⑨	Base	_____	1	Nylon	White	_____
⑧	Slider	_____	1	POM	Green	_____
⑦	Protecting Cover	_____	1	Nylon	Nature	_____
⑥	Spring	_____	1	Stainless Steel	Nature	_____
⑤	Contact	_____	2	Composite gold	_____	_____
④	Cover	_____	1	PC	Nature	_____
③	Keystroke	_____	1	POM	White	_____
②	Static Plate	_____	1	Copper Alloy	Nature	_____
①	Movable Plate	_____	1	Copper Alloy	Nature	_____
ITEM	PART NAME	TER'NO.	QTY.	MATERIAL	FINISHING	REMARK

APPROVALS		DATE	 Kailh	东莞市凯华电子有限公司 KATHUA ELECTRONICS CO., LTD		
DRAWN	L.Zhang	2016. 11. 18				
CHECKED				TITLE:	PG1511F Keystroke Switch	
APPROVALS				PART NO:	CPG1511F01S02	
TOLERANCES ARE	30<L	±0.30	ANGLE	UNIT: mm	SCALE: 1:1	PROJ: 
	10<l≤30	±0.20				
	5<l≤10	±0.15				
	l≤5	±0.10				
		±2°	DRAWING NO.	KHA-PG1511F-002EN	SHEET: 10F1	

A						
	ECN-2012-23	H	2020.12.25	NOTE "Ⓢ" EXTENDED MOVABLE PLATE , "Ⓢ" REVISE DEGREE OF PROTECTION	Xiao Yijiang	
	ECN-1904-40	G	2019.05.16	NOTE "Ⓢ" MATERIAL OF STATIC PLATE CHANGED TO COPPER ALLOY & MODIFIED BASE SHAPE WITH STAMPED "Ⓢ" POSITION	L.Zhang	
	_____	A	_____	NEW	_____	_____
	ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.
						APPRO.

Product Specification



White Shaft

P/N: CPG1511F01S02			Title : PG1511F Key Switch		
Rev.	ECN	Release and Revision Description:	Prepared By /Date:	Checked By/Date:	Approved By/Date:
G	— —	The moving pin has been/waterproof grade update	xiaoyijiang/2020.12.24	lvpanhao/2020.12.24	zhengjianjun/2020.12.24

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9. Recommended PCB Layout:	10
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1. Scope:

This Product Specification covers the requirement of Mechanical Keyboard switch on product performance, test methods and quality assurance provisions.

2. Product Application:

Mainly applied on computer keyboards, cash registers, industrial equipment and Man-Machine interface.

3. Technology Parameters:

Ambient Humidity:	45~85% R.H.;
Operating Temperature Range:	-10℃~+70℃;
Storage Temperature Range:	-20℃~+70℃;
Suggested storage period :	about 6 months
Require the tin part on the switch terminals should keep good after storage guarantee date	

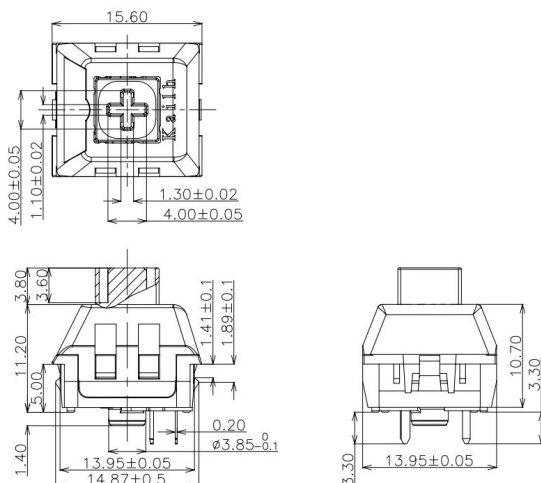
Normal Condition:

Ambient temperature:	20±2℃
Relative humidity:	65%±5% R.H.;
Air pressure :	86~101KPa;
Solder Ability :	Tim-lead soldering : 245℃±5℃ 5s±0.5s;
	Lead-free welding : 255℃±5℃ 5s±0.5s;
Withstand Soldering Temperature:	Wave soldering: 260±5℃ 5±0.5s;

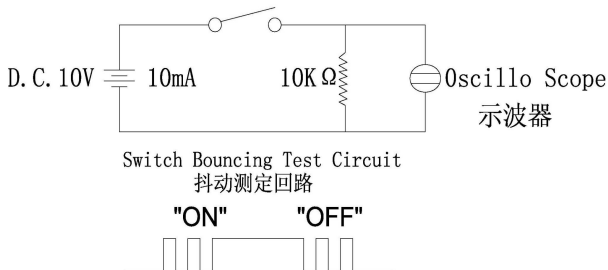
4. Ratings:

Rating:	12V AC/DC max. 2V DC min.
	10mA AC/DC max. 10 μ A DC min;
Insulation Resistance:	≥100MΩ/DC 100V;
Withstand Voltage:	100V AC 1 Minute;
Mechanical Life:	80,000,000 Cycles.

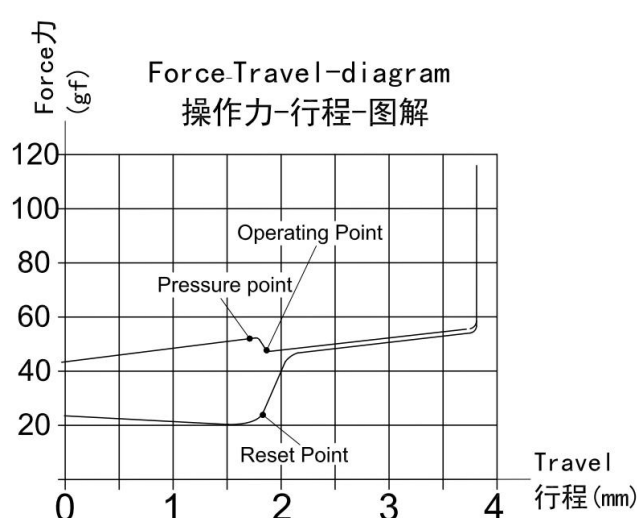
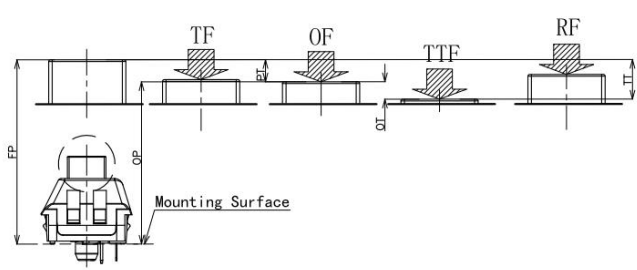
5. Profile Dimensions :

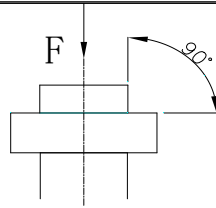


6. Electrical Performance:

Item	Description	Test Condition	Requirement
6.1	Contact Resistance	<p>Static load: (Operation force)x2, which is applied on the center of Switch stem. Be measured when the switch contact stabilization.</p> <p>Measurement tool: Contact resistance Meter. (1KHz, 20mV, 5~50mA)</p> <p>Measured at low current (100mA or less).</p>	200mΩ Max
6.2	Insulation Resistance	<p>Apply a Voltage of DC 100 V for 1 minute, according to the below method.</p> <p>(1) Between terminals. (2) Between terminal and Body.</p>	100MΩ Min
6.3	Dielectric withstanding voltage	<p>Apply a Voltage of AC100 V (50~60Hz) for 1 minute, according to the below method.</p> <p>(1) Between terminals. (2) Between terminal and Body.</p>	No evidence of breakdown.
6.4	Bouncing	<p>Operation speed: 3~4 times/s Oscillo scope Switch Bouncing Test Circuit.</p>  <p>Switch Bouncing Test Circuit 抖动测定回路</p> <p>"ON" "OFF"</p>	<p>Before Life cycle: On: 5ms MAX Off: 5ms MAX</p> <p>After Life cycle: On: 10ms MAX Off: 10ms MAX</p>

7. Mechanical Performance:

Item	Description	Test Condition	Requirement
7.1	Load Curve	<p>Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop.</p>  <p>Force (gf)</p> <p>Force-Travel-diagram 操作力-行程-图解</p> <p>Operating Point</p> <p>Pressure point</p> <p>Reset Point</p> <p>Travel 行程 (mm)</p>	See page 11
7.2	Loading parameter	<p>Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop.</p>  <p>TF</p> <p>OF</p> <p>TTF</p> <p>RF</p> <p>Mounting Surface</p>	See page 11
7.3	Static Strength	<p>A static load of 3kgf shall be applied in the direction of button operation for a period of 60 seconds.</p>	No damage (Electrical) And mechanical)



7.4

Stem Pull Strength

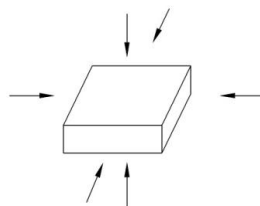
Break by a pull force applied opposite to the direction of stem operation.

5kgf Min

7.5

Shock

Measured by according to the below condition:
 (1) Acceleration: 80g accelerated speed
 (2) Cycles of test: 3 cycles each in 6 directions, for a total of 18 cycles.



Shall meet No.6, 7.1, 7.2.

7.6

Life Test

1) D.C.12V 10mA resistance load
 2) Operation speed : 5-6 times / s
 3) Push force : 150gf
 4) Operation number: 80,000,000cycles

Contact resistance:
 1 Ω Max
 Bouncing: 10ms Max
 Operation force and tactile force: Variation rate within $\pm 30\%$

8. Environmental Performance:

Item	Description	Test Condition	Requirement
------	-------------	----------------	-------------

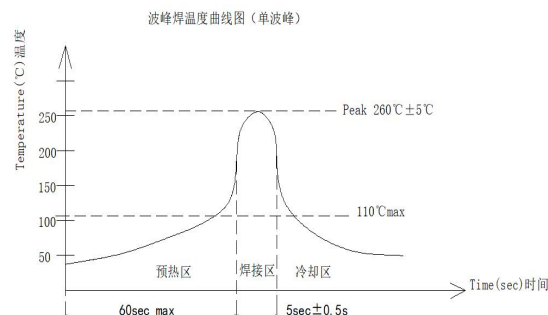
8.1	Cold test	(1) Temperature : $-20 \pm 2^{\circ}\text{C}$ (2) Duration of test: 48h (3) Take off a drop water (4) Standard conditions after test : 1	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2
-----	-----------	---	--

8.2	Heat test	(1) Temperature : $70 \pm 2^{\circ}\text{C}$ (2) Duration of test: 48h (3) Take off a drop water (4) Standard conditions after test : 1h	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2
-----	-----------	---	--

8.3	Temperature cycle	(1) Test cycles: 5 cycles (2) Standard condition after test: 1h	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2
-----	-------------------	--	--

	Temperature	Duration of test
1 cycle	$20 \pm 5^{\circ}\text{C}$	1h
	$-20 \pm 5^{\circ}\text{C}$	1h
	$20 \pm 5^{\circ}\text{C}$	1h
	$70 \pm 5^{\circ}\text{C}$	1h

8.4	Soldering heat test	Soldering area: 1/2 of PWB thickness. (PWB: T=1.6mm) Soldering temperature: $260 \pm 5^{\circ}\text{C}$ Soldering time: $5 \pm 0.5\text{s}$	Appearance: No abnormality.
-----	---------------------	--	--------------------------------



8.5	Solder ability	<p>Lead-tin soldering: Soldering temperature: $245 \pm 5^{\circ}\text{C}$ Soldering time: $5 \pm 0.5\text{s}$</p> <p>Lead free soldering: Soldering temperature: $255 \pm 5^{\circ}\text{C}$ Soldering time: $5 \pm 0.5\text{s}$</p>	At least 90% of surface area of immersed portion shall be covered by solder.
8.6	Humidity test	<p>(1) Temperature : $60 \pm 2^{\circ}\text{C}$ (2) relative humidity: 90~95% R.H. (3) Duration of test: 48h (4) Take off a drop water (5) Standard conditions after test: 1h</p>	<p>Contact resistance: $200\text{m}\Omega$ Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2</p>
8.7	Salt Spray	<p>Apply the following environment to test(Only for contact test) :</p> <p>(1) Temperature : $35 \pm 5^{\circ}\text{C}$ (2) Salt water density: $5 \pm 1\%$ (3) Duration: 12hours (4) After test, the salt deposit shall be removed by running water.</p>	<p>Appearance: No corrosion spot, no crack, no base plate naked.</p> <p>Contact Resistance: $200\text{m}\Omega$ Max</p>
8.8	Protection Against ingress of dust(IP5X)	<p>The switches are placed in a position of normal use inside the test chamber. The test is carried out according to the second enclosure of IEC60529/GB4208. The test shall be continued for a period of 8h.</p>	<p>After test: Operating is normal Between terminals, terminal and surface of the crust, Dielectric withstand in voltage $\geq 100\text{V}$</p>

8.9

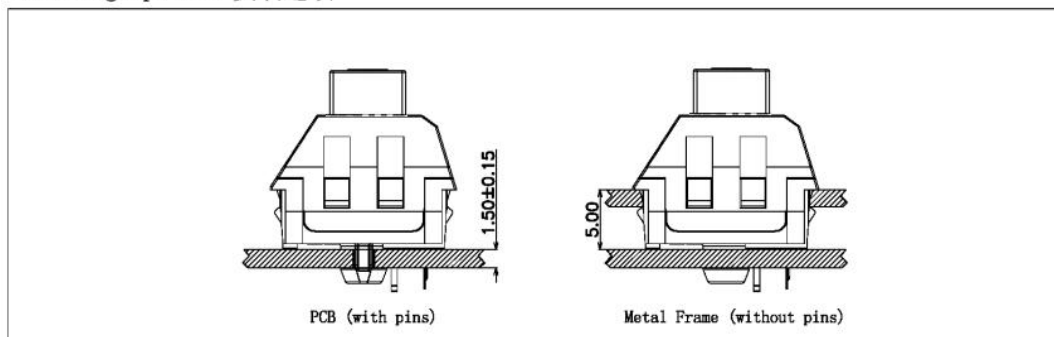
Protection
against ingress
of water(IPX4)

The switches are placed in a position of
normal use inside the test table.
The test is carried out according to the
second enclosure of IEC60529/GB4208.

After test:
Operating is normal.
Water don't enter electric
parts of the switch inside.
Between terminals,
terminal and surface of the
crust,
Dielectric withstand in
voltage $\geq 100V$

9. Recommended PCB Layout

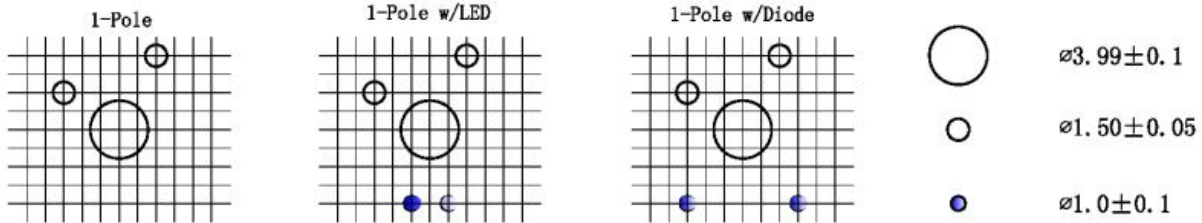
Mounting Options 安装选项



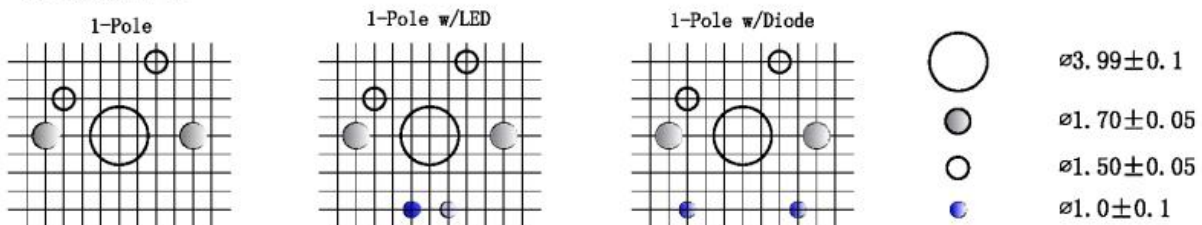
Circuit Board Layouts 电路板布局

Grid line spacing = 1.27mm 网格线间距= 1.27毫米

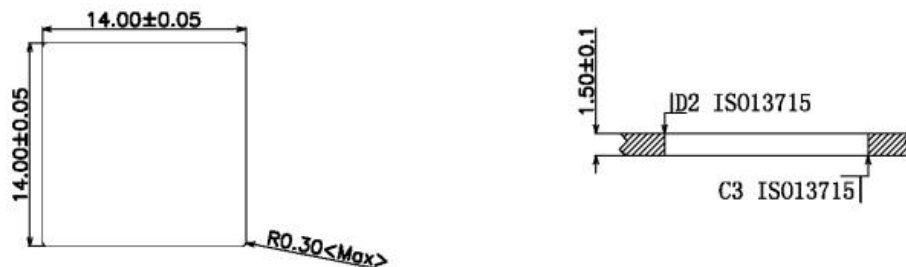
Keyswitch without fixation pins
按键开关不带定位柱



Keyswitch with fixation pins
按键开关带定位柱



Metal Frame Cutout Dimensions

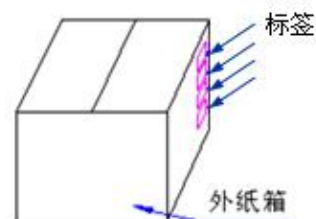
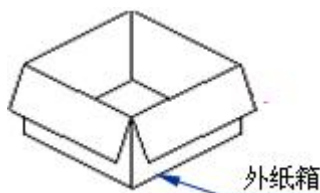


10. Loading Parameter (TT/PT/OT /OF/TF/RF) Specification :

Parameter	Unit	Specification	Remark
TT	mm	3.60±0.3	
PT	mm	1.80±0.3	
OT	mm	1.30	Min.
TF	gf	55±10	
OF	gf	45±15	
RF	gf	15	Min.

11. Packaging :

Packaging type: Tray, 1000Pcs/Tray, 4000Pcs/Carton.



12. Precaution

12.1 Immersion Soldering condition

ITEM	CONDITION
Preheat temperature	110℃ Max (Ambient temperature of soldering surface of P.W.B)
Preheat time	60s, Max
Area of flux	1/2 Max of PWB Thickness
Temperature of solder	260±5℃ 260±5℃
Time of immersion	5±0.5s 5±0.5s
Number of soldering	2time Max (But should down heat of the first soldering)
Printed wiring board	Single side copper-clad laminates

(1) After switches were soldered, please be careful not to clean switches with solvent

(2) Under the condition of using soldering iron, soldering temperature shall be 350℃±5℃ with 3±0.5s.

12.2 Notes

- Please be cautious not to give excessive static load or shock to switches.
- Please be careful not to stack up P. W. B. after switches were soldered.
- Preservation under high temperature and high humidity or corrosive gas should be avoided
Especially. When you need to preserve for a long period, do not open the carton.
- The standard storage period is 3 months, with maximum up to 6months, preferably to be used as soon as possible. After opening the package, you should put the remaining switches in a plastic bag to prevent from damp and corrosive gas.
- This Product Specification is considered as the technical agreement on product between the receiving customer and Kailh. Any information on Product Catalogue which is in conflict with

or different from the corresponding information of this document is considered as invalid.

(6) It will be considered that customer already confirmed and accepted this specification if customer issue purchase order to us directly.

(7) If there is no order or no request for new specification after 1 year upon this specification is issued,

the specification will be regarded as invalid.

(8) Products meet the ROHS & REACH environmental management substances control standards